Doc#: 329557.1 MLW/CSK/man 07/29/02

IN THE UNITED STATES PATENT AND TRADEMARK OF FICE

Applicants:

Matthew B. Wall and Timothy R. Wall

RECEIVED

DOCKET NO.: 2767.2001-00

Application No.:

09/898,527

Group Art Unit: 2122

AUG 0 5 2002

Filed:

July 3, 2001

Examiner: Not assigned.

Technology Center 2100

Title:

METHOD FOR MAPPING BUSINESSES PROCESSES USING A EMERGENT MODEL ON A COMPUTER NETWORK



CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to Assistant Commissioner for Patents, P.O. Box 2327, Arlington, VA 22202

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents P.O. Box 2327 Arlington, VA 22202

Sir:

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Thic	Intormation	I licelocure	Statement i	is submitted:
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[] under 37 CFR 1.129(a), or

(First/Second submission after Final Rejection)

[X]under 37 CFR 1.97(b), or

> (Within any one of the following time periods: three months of filing national application (other than a CPA) or date of entry of the national stage in an international application; or before the mailing date of a first office action on the merits in a non-provisional application, including a CPA, or a Request for Continued Examination).

[] under 37 CFR 1.97(c) together with either:

a Statement under 37 CFR 1.97(e), as checked below, or

a \$180.00 fee under 37 CFR 1.17(p), or

(After the 37 CFR 1.97(b) time period, but before final action or notice of allowance, whichever occurs first)

[] under 37 CFR 1.97(d) together with:

a Statement under 37 CFR 1.97(e), as checked below, and

a \$180.00 fee under 37 CFR 1.17(p), or

(Filed after final action or notice of allowance, whichever occurs first, but on or before payment of the issue fee)

under 37 CFR 1.97(i):

Applicant requests that the IDS and cited reference(s) be placed in the application filewrapper.

(Filed after payment of issue fee)

Statem	ient Und	<u>der 37 C</u>	<u>CFR 1.97(e)</u>			
[]	Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement; or					
[]	No item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned, after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of this Information Disclosure Statement.					
Statem	ent Une	der 37 <u>C</u>	(Patent Term Adjustment) Applies to original applications (other than design) filed on or after May 29, 2000			
[]	commi	unicatio ot receiv	nformation contained in the Information Disclosure Statement was cited in a n from a foreign patent office in a counterpart application and this communication ed by any individual designated in § 1.56(c) more than thirty days prior to the formation Disclosure Statement.			
[X]	Enclos	ed here	with is form PTO-1449:			
	[X]	Copies	of the cited references are enclosed.			
	[]	Applic	of cited references are enclosed except those entered in prior application, U.S. ation No. [], to which priority under 35 U.S.C. 120 is claimed. [The earlier ation contains copies of the cited references.]			
	[]	The lis	listed references were cited in the enclosed International Search Report in a nterpart foreign application.			
	[X]	The "c	oncise explanation" requirement (non-English references) for reference(s) AL 37 CFR 1.98(a)(3) is satisfied by:			
		[]	the explanation provided on the attached sheet.			
		[]	the explanation provided in the Specification.			
		[]	submission of the enclosed International Search Report.			
		[]	submission of the enclosed English-language version of a foreign Search Report and/or foreign Office Action.			
		[X]	the enclosed English language abstract.			

[]	Applic	cant requests that the following r	non-published pending applic	cations be considered:
Examiner's Initials	i.			
		U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
		U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
		U.S. Patent Application No. [], by [inventor(s)], filed [], Docket No.: []
		Examiner	Date	_
	[]	A copy of each above-cited app	plication, including the curre	nt claims, is enclosed.
	[]	A copy of each above-cited app those entered in prior application 35 U.S.C. 120 is claimed.	plication, including the curre on, U.S. Application No. [nt claims, is enclosed, except], to which priority under
The E	xamine nces we	r is requested to return a copy of re considered with the next office	the above list of pending appear communication.	plications indicating which
It is re	quested	that the information disclosed h	erein be made of record in the	his application.
Metho	od of pa	vment:		
[]	A che	ck for the fee noted above is encorpanying Reply. A copy of this S		cluded in the check with the
[]	Please	charge Deposit Account 08-038 ed.	30 in the amount of \$[. A copy of this Statement is
[X]	Please	charge any deficiency in fees ar	nd credit any overpayment to	Deposit Account 08-0380.
		I	Respectfully submitted,	
		I	HAMILTON, BROOK, SMI	TH & REYNOLDS, P.C.
		I	C. Steven Kurlowecz Registration No.: 46,846 Telephone: (978) 341-0036 Facsimile: (978) 341-0136	Kurlowg

Concord, MA 01742-9133 Dated: 7/29/2

PTO-1449 REPRODUCED			ATTORNEY DOCKET NO. 2767.2001-005	APPLICATION NO. 09/898,527				
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			U.S. PA	ATENT DOCUMENTS				
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	AA	5,317,729	05/31/94	Mukherjee et al.	395	600	-	
	AB	5,517,655	05/14/96	Collins et al.	395	800 ह	R	
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	AD	5,724,575	03/03/98	Hoover et al.	395	610 Q	o ™	
	AE	5,796,986	08/18/98	Fuller	395	500		
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	AL 🗸	WO 98/15908	10 Aug 97	PCT				
	AM						,	
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	AO							
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	AV /	"Project JXTA: Technical Specification, Version 1.0," Sun Microsystems, Inc., 4/25/01 (26 pp.).						
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	AU2	collaborative development of complex engineering products, " Advanced						
	AV2	Fisher, M., "Zer pp.)	Fisher, M., "Zero-latency Engineering™", Aviatis Corporation, 1999 (16 pp.)					
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